- Drafts
  - BRS:
- Pending
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  - L8: (247) chip same module same first same second same (stack or to
  - L9: (185) 6 and semiconductor
- Failed
  - (0) 6 and (memory same (element$ or cell$)
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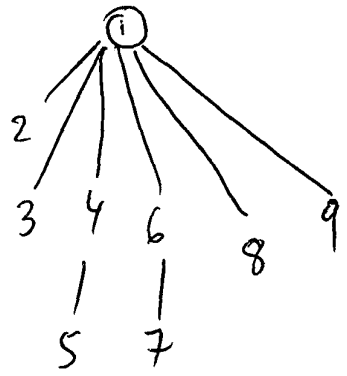
6 and semiconductor

	U	L	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	Retrieval C	Inventor	S	C	P	J	Im
1			US 6487085 B1	20021126	16	High-frequency module and method of manufacturing the	361/763	174/52.1; 174/52.4;		Kimura, Junichi et al.					US
2			US 6487078 B2	20021126	14	Electronic module having a three dimensional array of	361/704	165/185; 165/80.2;		Kledzik, Kenneth J. et al.					US
3			US 6486549 B1	20021126	44	Semiconductor module with encapsulant base	257/723	257/687; 257/693;		Chiang, Cheng-Lien					US
4			US 6485814 B1	20021126	13	High density thin film circuit board and method of	428/210	174/263; 174/264;		Morizumi, Kiyokazu et al.					US
5			US 6479299 B1	20021112	41	Pre-disposed assay components in microfluidic	436/514	204/450; 204/451;		Parce, J. Wallace et al.					US
6			US 6470482 B1	20021022	42	METHOD AND SYSTEM FOR CREATING, DERIVING AND	716/6	716/2; 716/5		Rostoker, Michael D. et al.					US
7			US 6462976 B1	20021008	33	Conversion of electrical energy from one form to	363/147	361/794		Olejniczak, Kraig J. et al.					US
8			US 6456767 B2	20020924	15	Optical waveguide transmitter-receiver module	385/49	385/14; 385/83		Terashima, Tokihiro					US
9			US 6452266 B1	20020917	42	Semiconductor device	257/723	257/724; 257/780		Iwaya, Akihiko et al.					US
10			US 6438014 B2	20020820	44	High speed access compatible memory module	365/63	365/51; 365/52		Funaba, Seiji et al.					US
11			US 6429025 B1	20020806	42	High-throughput screening assay systems in microscale	436/514	204/400; 204/451;		Parce, John Wallace et al.					US

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